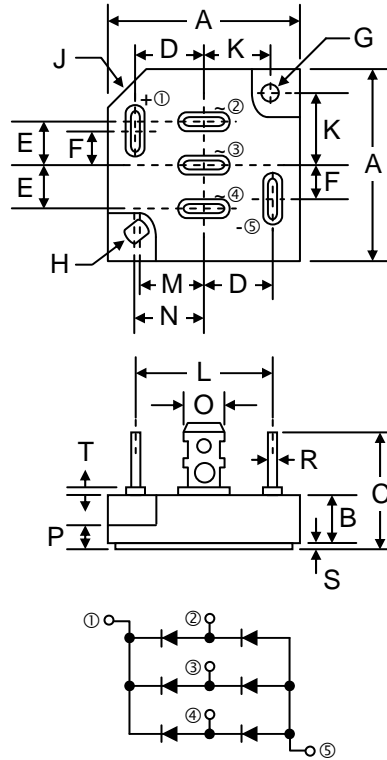


Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards
- Plastic Material has UL Recognition
Flammability Classification Rating 94V-0

Mechanical Data

- Case: Epoxy Case
Mounted in the Bridge Encapsulation
- Terminals: Plated Faston Lugs Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram Below
- Weight: 45 grams (approx.)
- Mounting Position: Bolt Down on Heatsink With Silicone Thermal Compound Between Module and Mounting Surface for Maximum Heat Transfer Efficiency
- Mounting Torque: 0.8 N.m Max.
- Marking: Type Number
- **Lead Free: For RoHS / Lead Free Version, Add "-LF" Suffix to Part Number, See Page 4**



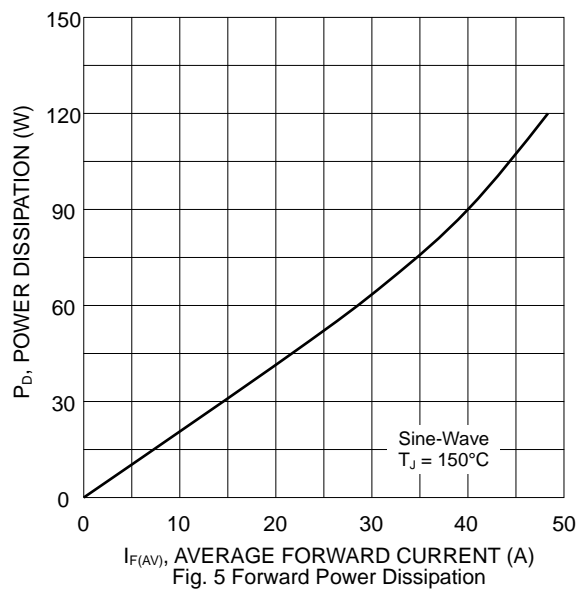
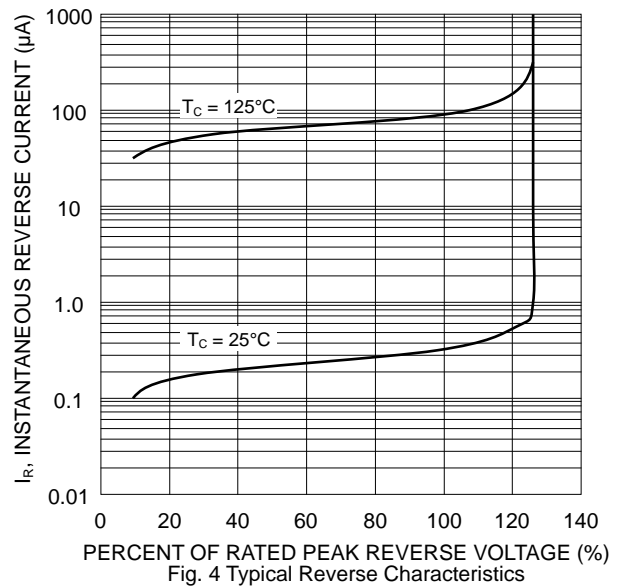
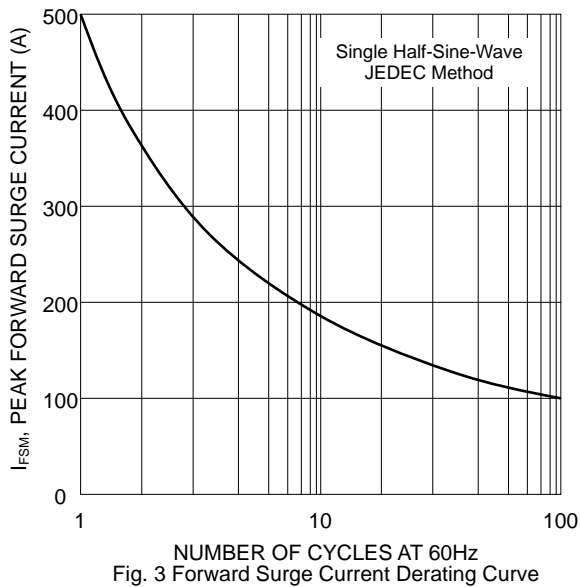
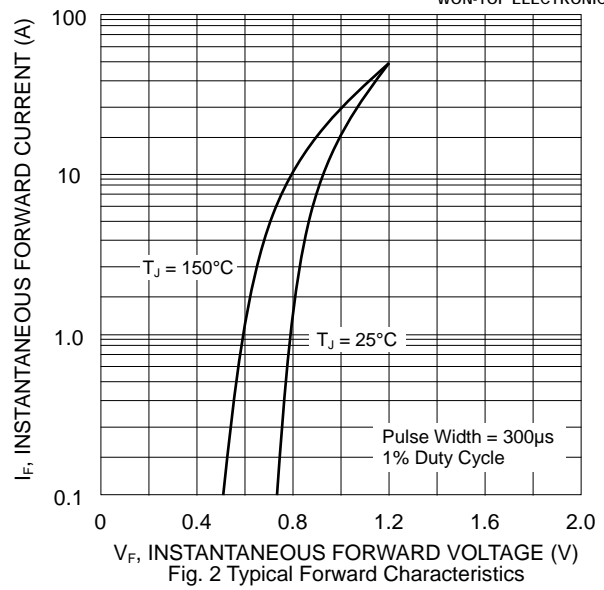
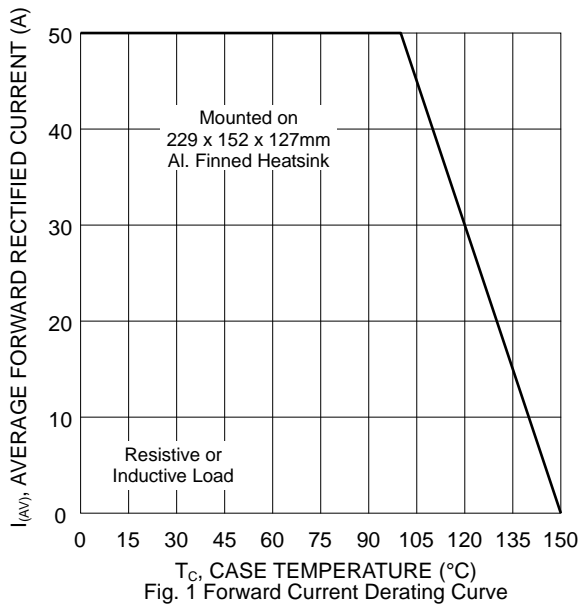
SVT		
Dim	Min	Max
A	34.5	36.0
B	9.8	10.4
C	27.0	29.0
D	13.1	14.1
E	8.5	9.5
F	6.5	7.5
G	3.5 Ø Typical	
H	R 1.75 Typical	
J	3.7 x 45°	
K	—	12.8
L	26.2	28.2
M	—	12.5
N	—	13.1
O	6.2	6.5
P	5.5	6.5
R	0.7	0.9
S	1.0	1.8
T	1.4	1.6
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

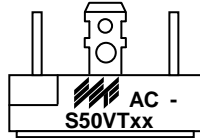
Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	S50VT60	S50VT80	S50VT160	Unit
Peak Repetitive Reverse Voltage	V _{RRM}				
Working Peak Reverse Voltage	V _{RWV}	600	800	1600	V
DC Blocking Voltage	V _R				
RMS Reverse Voltage	V _{R(RMS)}	420	560	1120	V
Average Rectified Output Current @T _C = 100°C	I _O		50		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}		500		A
Forward Voltage per diode @I _F = 17.5A	V _{FM}		1.05		V
Peak Reverse Current At Rated DC Blocking Voltage	I _{RM}		10		µA
I ² t Rating for Fusing per diode (1ms < t < 10ms)	I ² t		500		A ² s
Thermal Resistance Junction to Case (Note 1)	R _{JC}		0.7		°C/W
RMS Isolation Voltage Terminals to Case, t = 1min	V _{ISO}		2000		V
Operating and Storage Temperature Range	T _J , T _{STG}		-55 to +150		°C

Note: 1. Mounted on 229 x 152 x 127mm Al. finned heatsink.



MARKING INFORMATION



S50VTxx = Device Number
 xx = 60, 80 or 160
 Polarity = As Marked on Body

PACKAGING INFORMATION

BULK

Inner Box Size L x W x H (mm)	Quantity (PCS)	Carton Size L x W x H (mm)	Quantity (PCS)	Approx. Gross Weight (KG)
195 x 195 x 40	25	405 x 205 x 240	250	12.0

Note: 1. Paper box, white or brown color.

ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
S50VT60	Bridge Module	25 Units/Box
S50VT80	Bridge Module	25 Units/Box
S50VT160	Bridge Module	25 Units/Box

1. Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.
2. **To order RoHS / Lead Free version (with Lead Free finish), add "-LF" suffix to part number above. For example, S50VT60-LF.**

WON-TOP ELECTRONICS and  are registered trademarks of Won-Top Electronics Co., Ltd (WTE). WTE has checked all information carefully and believes it to be correct and accurate. However, WTE cannot assume any responsibility for inaccuracies. Furthermore, this information does not give the purchaser of semiconductor devices any license under patent rights to manufacturer. WTE reserves the right to change any or all information herein without further notice.

WARNING: DO NOT USE IN LIFE SUPPORT EQUIPMENT. WTE power semiconductor products are not authorized for use as critical components in life support devices or systems without the express written approval.

Won-Top Electronics Co., Ltd.
No. 44 Yu Kang North 3rd Road,
Chine Chen Dist., Kaohsiung 806, Taiwan
Phone: 886-7-822-5408 or 886-7-822-5410
Fax: 886-7-822-5417
Email: sales@wontop.com
Internet: <http://www.wontop.com>

We power your everyday.